





Coupled Inductor - NA5880-AE



Part	Inductance ²	Turns	DCR max (Ohms)		SRF typ ³	Isat ⁴
number ¹	±20% (μH)	ratio	L1	L2	(MHz)	(A)
NA5880-AE_	3.3	1:4	0.306	2.30	12	1.3

1. When ordering, please specify **packaging** code:

NA5880-AEC

- **Packaging:** C = 7" machine-ready reel. EIA-481 embossed plastic tape (1000 parts per full reel).
 - B = Less than full reel. In tape, but not machine ready. To have a leader and trailer added (\$25 charge), use code letter D instead.
 - D = 13" machine-ready reel. EIA-481 embossed plastic tape. Factory order only, not stocked (3500 parts per full reel).
- 2. Inductance is for the primary (L1), measured at 100 kHz, 0.1 Vrms, 0 Adc on an Agilent/HP 4284A LCR meter or equivalent.
- 3. SRF measured using an Agilent/HP 4191A or equivalent.
- 4. DC current applied to L1, at which the inductance drops 10% from its value without current.
- 5. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

- Developed for use with Fairchild Semiconductor FAN8831 Sinusoidal Piezoelectric Actuator Driver
- 1: 4 turns ratio; Output voltages up to 300 V

Core material Ferrite

Environmental RoHS compliant, halogen free

Terminations RoHS compliant matte tin over silver-palladiumplatinum-glass frit.

Weight 64 mg

Ambient temperature -40°C to +85°C

Maximum part temperature +165°C (ambient + temp rise).

Storage temperature Component: -40°C to +125°C.

Tape and reel packaging: -40°C to +80°C

Winding to winding isolation (Hipot) 300 V

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Failures in Time (FIT) / Mean Time Between Failures (MTBF) 38 per billion hours / 26,315,789 hours, calculated per Telcordia SR-332 Packaging 1000/7" reel; 3500/13" reel Plastic tape: 12 mm wide, 0.25 mm thick, 8 mm pocket spacing, 1.32 mm pocket depth Recommended pick and place nozzle OD: 4 mm; ID: \leq 2 mm PCB washing Tested to MIL-STD-202 Method 215 plus an additional aqueous wash. See Doc787_PCB_Washing.pdf.



